N-Channel 20-V (D-S), 175 °C MOSFET

PRODUCT SUMMARY			
V_{DS} (V)	$r_{DS(on)}$ (Ω)	I_D (A)[a]	Q_g (Typ)
20	0.0033 at V_{GS} = 10 V	40	30 nC
	0.0044 at V_{GS} = 4.5 V	40	

FEATURES

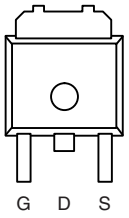
- TrenchFET® Power MOSFET
- 100 % R_g Tested

RoHS COMPLIANT

APPLICATIONS

- Server

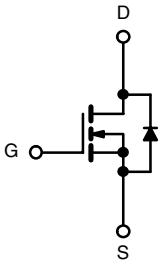
TO-252



Drain Connected to Tab

Top View

Order Number:
SUD40N02-3m3P-E3 (Lead (Pb)-free)



N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS T_A = 25 °C, unless otherwise noted				
Parameter		**Symbol**	**Limit**	**Unit**
Drain-Source Voltage		V_{DS}	20	V
Gate-Source Voltage		V_{GS}	± 20	
Continuous Drain Current (T_J = 150 °C)	T_C = 25 °C	I_D	40[a]	A
	T_C = 100 °C		40[a]	
	T_A = 25 °C		24.4[b]	
	T_A = 100 °C		17.2[b]	
Pulsed Drain Current		I_{DM}	100	
Continuous Source-Drain Diode Current	T_C = 25 °C	I_S	40[a]	
	T_A = 25 °C		2.8[b]	
Maximum Power Dissipation	T_C = 25 °C	P_D	79	W
	T_C = 100 °C		39.5	
	T_A = 25 °C		3.3[b]	
	T_A = 100 °C		1.6[b]	
Operating Junction and Storage Temperature Range		T_J, T_{stg}	- 55 to 175	°C

THERMAL RESISTANCE RATINGS					
Parameter		**Symbol**	**Typical**	**Maximum**	**Unit**
Maximum Junction-to-Ambient[b]	Steady State	R_{thJA}	37	45	°C/W
Maximum Junction-to-Case	Steady State	R_{thJC}	1.5	1.9	

Notes:
a. Package limited.
b. Surface Mounted on 1" x 1" FR4 board.

SPECIFICATIONS T_J = 25 °C, unless otherwise noted						
Parameter	**Symbol**	**Test Conditions**	**Min.**	**Typ.**	**Max.**	**Unit**
Static						
Drain-Source Breakdown Voltage	V_{DS}	V_{GS} = 0 V, I_D = 250 µA	20			V
V_{DS} Temperature Coefficient	$\Delta V_{DS}/T_J$	I_D = 250 µA		21		mV/°C
$V_{GS(th)}$ Temperature Coefficient	$\Delta V_{GS(th)}/T_J$			- 6.9		
Gate-Source Threshold Voltage	$V_{GS(th)}$	V_{DS} = V_{GS}, I_D = 250 µA	1		3	V
Gate-Source Leakage	I_{GSS}	V_{DS} = 0 V, V_{GS} = ± 20 V			± 100	nA
Zero Gate Voltage Drain Current	I_{DSS}	V_{DS} = 20 V, V_{GS} = 0 V			1	µA
		V_{DS} = 20 V, V_{GS} = 0 V, T_J = 100 °C			20	
On-State Drain Current[a]	$I_{D(on)}$	$V_{DS} \geq$ 5 V, V_{GS} = 10 V	30			A
Drain-Source On-State Resistance[a]	$r_{DS(on)}$	V_{GS} = 10 V, I_D = 20 A		0.0027	0.0033	Ω
		V_{GS} = 4.5 V, I_D = 20 A		0.0036	0.0044	
Forward Transconductance[a]	g_{fs}	V_{DS} = 15 V, I_D = 20 A		100		S
Dynamic[b]						
Input Capacitance	C_{iss}	V_{DS} = 10 V, V_{GS} = 0 V, f = 1 MHz		6520		pF
Output Capacitance	C_{oss}			1430		
Reverse Transfer Capacitance	C_{rss}			770		
Total Gate Charge	Q_g	V_{DS} = 10 V, V_{GS} = 10 V, I_D = 50 A		105	160	nC
		V_{DS} = 10 V, V_{GS} = 4.5 V, I_D = 50 A		50	75	
Gate-Source Charge	Q_{gs}			17		
Gate-Drain Charge	Q_{gd}			14		
Gate Resistance	R_g	f = 1 MHz		1.2	1.9	Ω
Turn-On Delay Time	$t_{d(on)}$	V_{DD} = 10 V, R_L = 0.2 Ω, $I_D \cong$ 50 A, V_{GEN} = 4.5 V, R_g = 1 Ω		40	60	ns
Rise Time	t_r			30	45	
Turn-Off Delay Time	$t_{d(off)}$			67	101	
Fall Time	t_f			33	50	
Turn-On Delay Time	$t_{d(on)}$	V_{DD} = 10 V, R_L = 0.2 Ω, $I_D \cong$ 50 A, V_{GEN} = 10 V, R_g = 1 Ω		13	20	
Rise Time	t_r			7	11	
Turn-Off Delay Time	$t_{d(off)}$			40	60	
Fall Time	t_f			9	14	
Drain-Source Body Diode Characteristics						
Continuous Source-Drain Diode Current	I_S	T_C = 25 °C			40	A
Pulse Diode Forward Current[a]	I_{SM}				100	
Body Diode Voltage	V_{SD}	I_S = 20 A		0.81	1.2	V
Body Diode Reverse Recovery Time	t_{rr}	I_F = 50 A, di/dt = 100 A/µs, T_J = 25 °C		38	57	ns
Body Diode Reverse Recovery Charge	Q_{rr}			34	51	nC
Reverse Recovery Fall Time	t_a			18		ns
Reverse Recovery Rise Time	t_b			20		

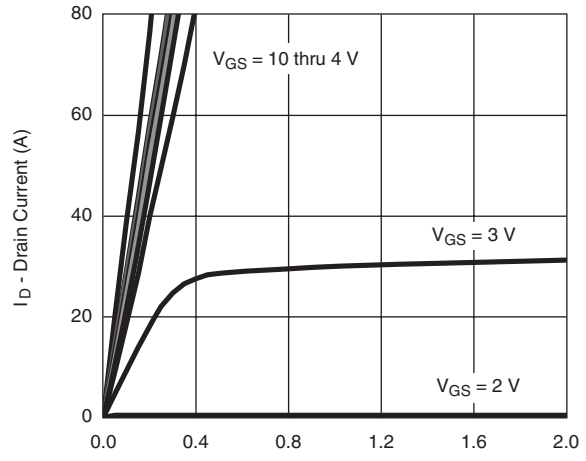
Notes:

a. Pulse test; pulse width ≤ 300 µs, duty cycle ≤ 2 %.

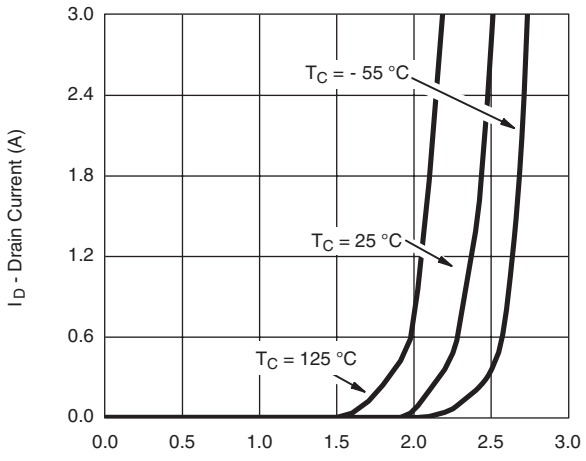
b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

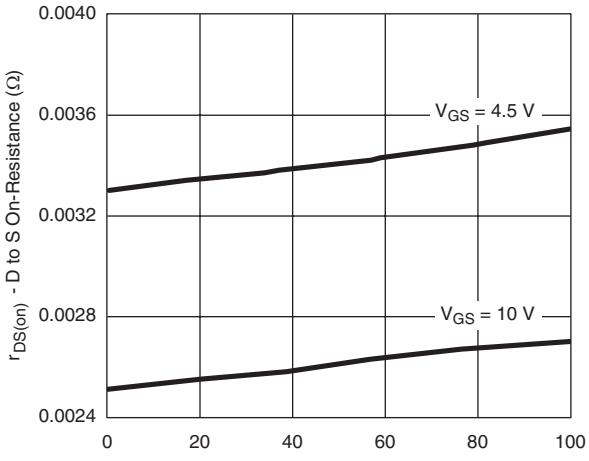
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



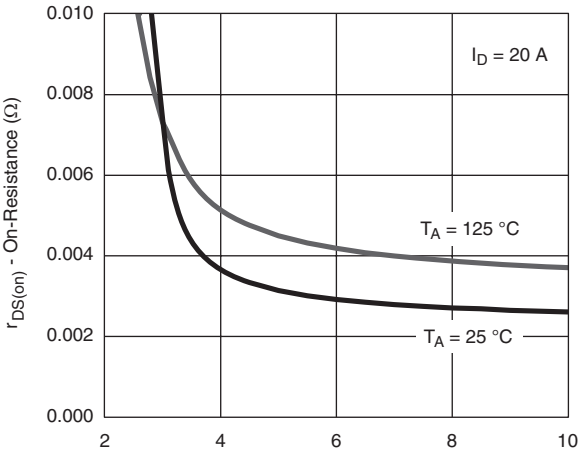
Output Characteristics



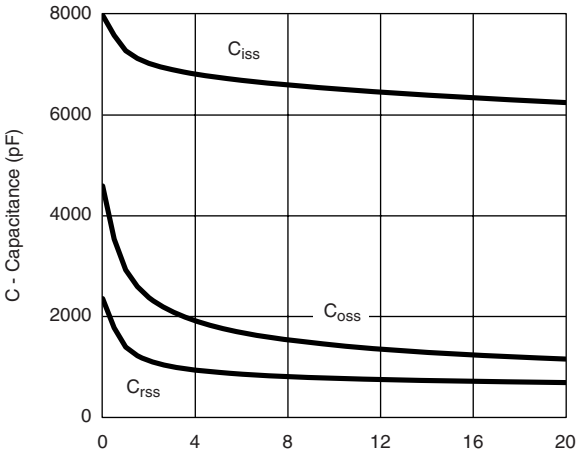
Transfer Characteristics



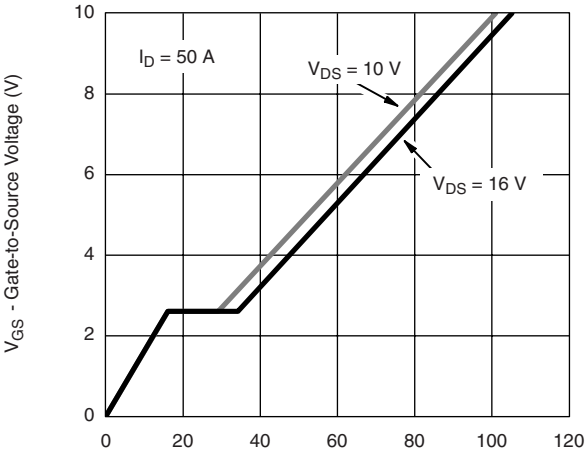
On-Resistance vs. Drain Current



On-Resistance vs. V_{GS} vs. Temperature

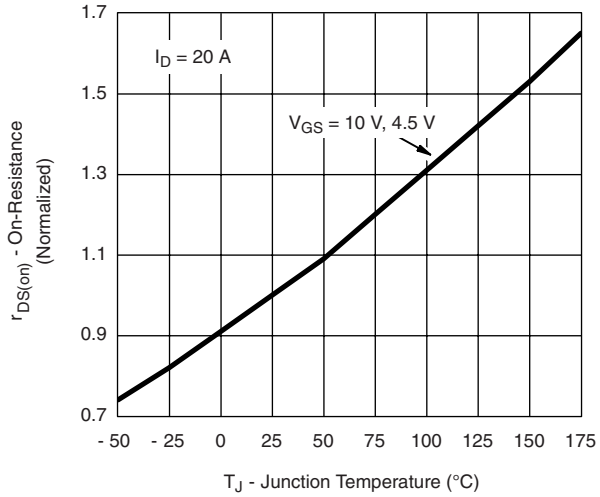


Capacitance

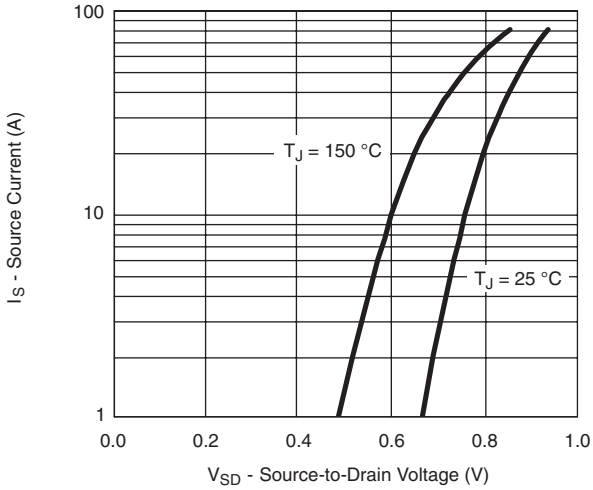


Gate Charge

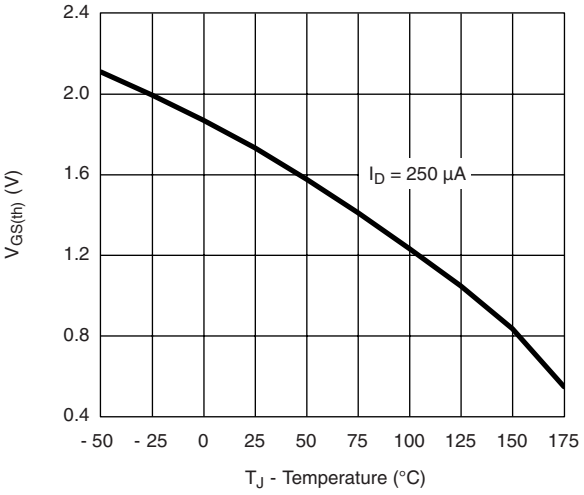
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



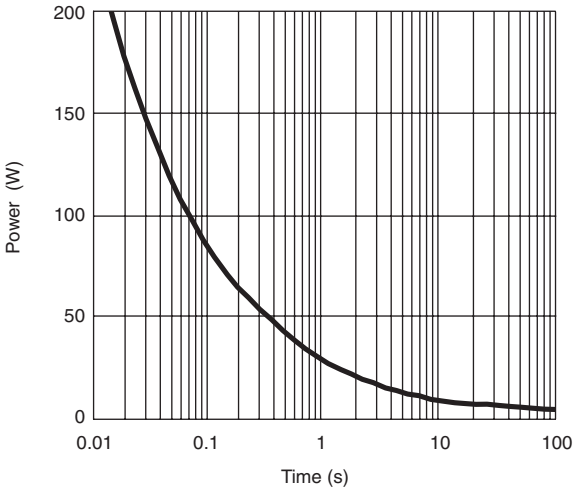
On-Resistance vs. Junction Temperature



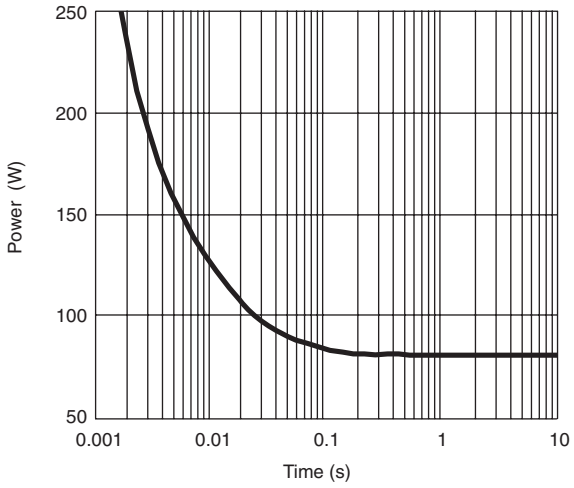
Forward Diode Voltage vs. Temperature



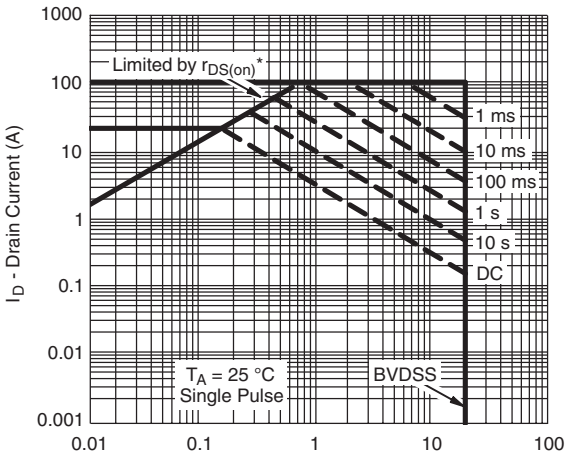
Threshold Voltage



Single Pulse Power, Junction-to-Ambient



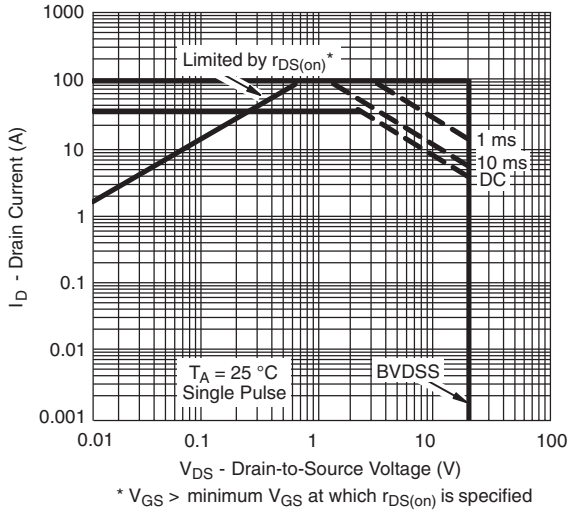
Single Pulse Power, Junction-to-Case



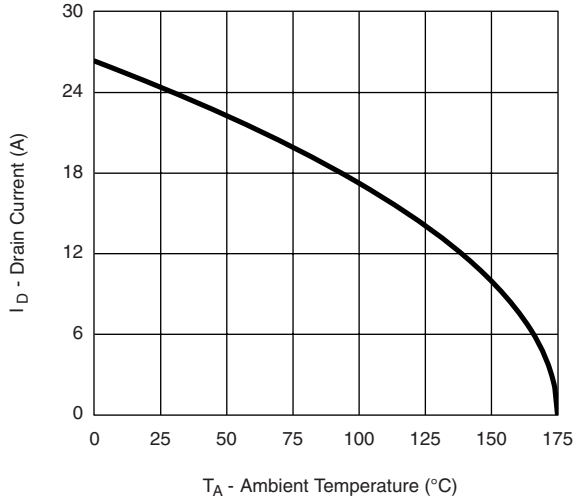
* V_{GS} > minimum V_{GS} at which $r_{DS(on)}$ is specified

Safe Operating Area, Junction-to-Ambient

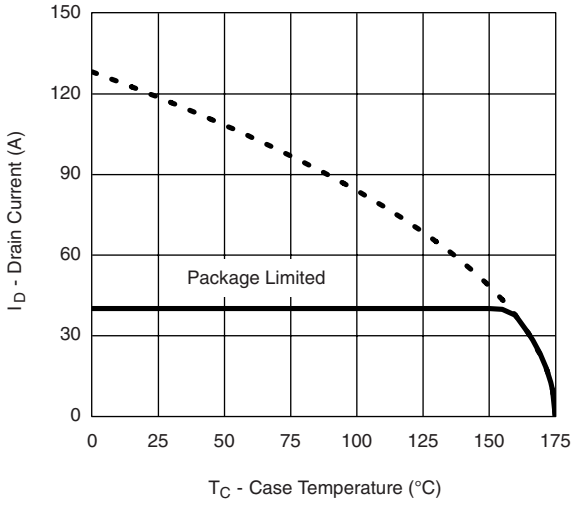
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



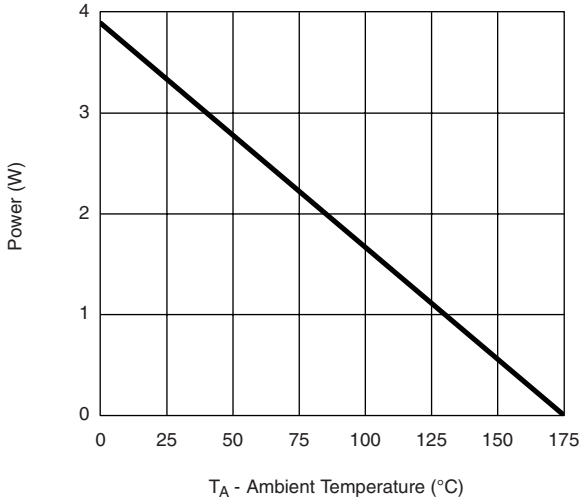
Safe Operating Area, Junction-to-Case



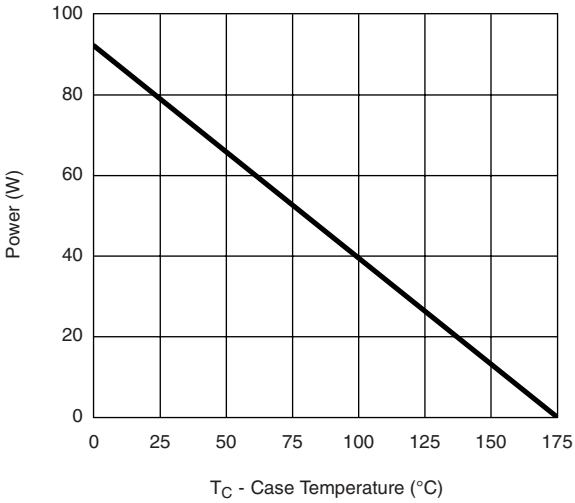
Current Derating, Junction-to-Ambient**



Current Derating, Junction-to-Case**



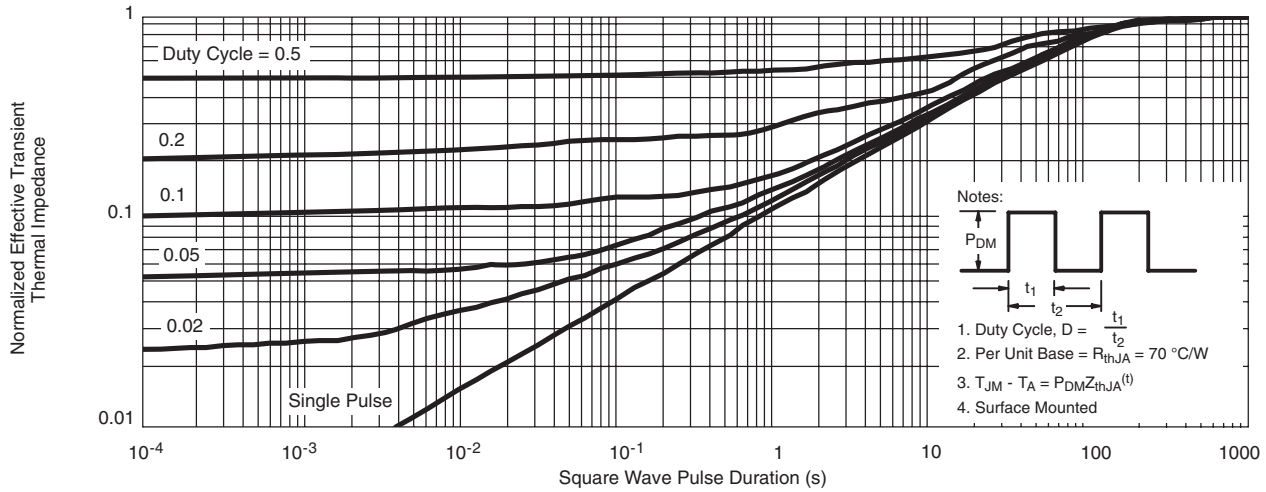
Power Derating, Junction-to-Ambient**



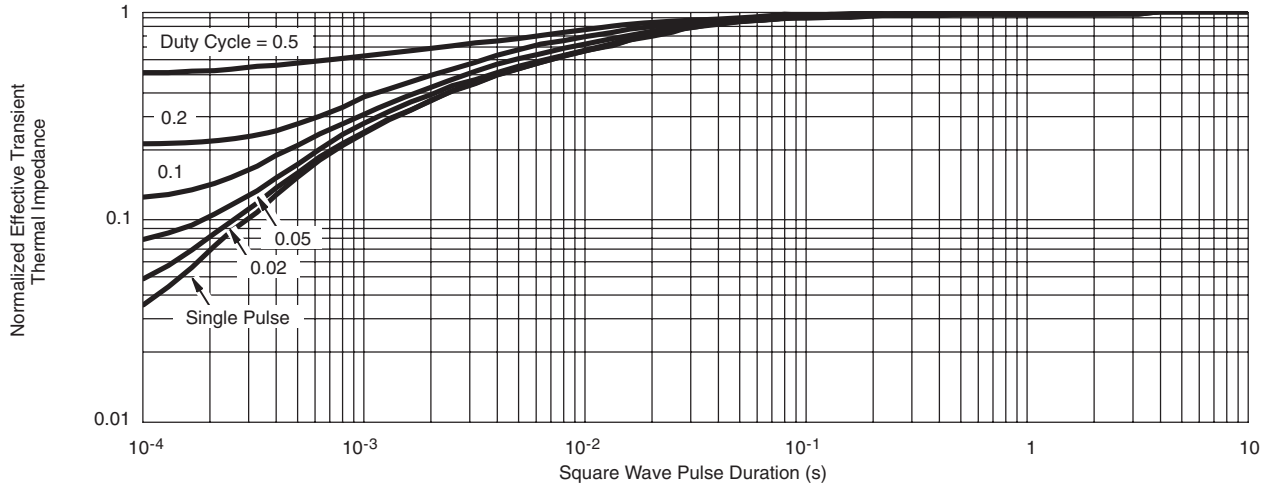
Power Derating, Junction-to-Case**

** The power dissipation P_D is based on $T_{J(max)}$ = 175 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

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